

ATLASPIX3.1 Beam Telescope Testbeam results

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Introduction

- ATLASPix3 general features
 - Depleted Monolithic Active Pixel Sensor (DMAPS)
 - HVCMOS technology
 - **TSI 180 nm process** on 200 Ωcm substrate
 - 132 columns of 372 pixels
 - full-reticle size 20×21 mm² monolithic pixel sensor
 - **pixel size 50×150** μ m² (25×150 μ m² on recent prototypes)
 - breakdown voltage ~-60 V
 - up to **1.28 Gbps downlink**
 - 25 ns timestamping
- INFN, KIT, China, UK collaboration





Single Chip Setup

- Readout using **GECCO** (GEneric Configuration and COntrol) system for single chip, quad and telescope
 - Diligent Nexys Video FPGA board + firmware
 - **GECCO board** (middle) with function card slots
 - Single chip card (can be swapped out)
 - Qt-based software GUI





Beam Telescope



- Using the same **GECCO system** with additional function cards
- One telescope adapter card provides slots for 4 planes with a distance of 2.54 cm
- Telescope firmware and software (similar to single chip)
- All telescope planes share the same HV and LV (voltages can be fine-tuned for each plane if regulators are used)
- in figure a simple model used for early tests



DESY Testbeam April 2022 (1)



- Two telescopes (**KIT** and **UK**) in standalone systems tested at **DESY** with electron beams
- For the presented data analysis
 - 3-6 GeV electrons beams
 - perpendicular beams
 - hit-driven RO
 - KIT and UK telescopes placed as in figure
 - HV scan for the UK telescope (2, 5, 10, 15, 20, 30, 40, 50 V)
- Data reconstruction
 - Corryvreckan
 - use L1 (ref), L2 and L4 as telescope planes for iterative alignment and tracks reconstruction
 - associate L3 as DUT plane
 - selected tracks with χ^2 /ndof<5
 - cluster associated if within 0.6mm from track interception

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DESY Testbeam April 2022 (2)



- Very new results presented in this talk
- Find previous results here
 - First Results of ATLASPix3.1 Telescope, The 31st International Workshop on Vertex Detectors, Talk, October 2022
 - First results of ATLASPix3.1 telescope, 10th International Workshop on Semiconductor Pixel Detectors for Particles and Imaging, Poster session, December 2022



Reference system



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Cross-talk



- Cross-talk between pixels due to the capacitive coupling of the transmission lines between the matrix and the end-of-column logic is limited to ~1% of total hits
 - cross-talk hits shows up in self correlation plots
 - they are contained in the low ToT peak



Time over Threshold (1)



- ToT increases with HV
- MPV (Most Probable Value) has linear behavior with \sqrt{V}
- ToT~69 at 0V from extrapolation



Time over Threshold (2)

Cluster charge map 40 V HV



- 2x2 pixel matrix
- Example for HV=40V
- Higher clusters ToT for tracks passing at the Y edge between two pixels

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Time over Threshold (3)



- in-pixel X projection for each HV
- Almost **uniform** clusters **ToT**
- ToT slightly lower at pixels sides



- in-pixel Y projection for each HV
- Almost uniform clusters ToT
- ToT slightly higher at pixel sides where the charge is shared between two pixels



Clusters row width



- **Distribution of cluster size** projection in **row** direction (50 µm pitch)
- Slightly increase with HV
- For HV>20V the region between pixels gets depleted
- In column direction (150 µm pitch) almost all cluster are single pixel due to the bigger pitch



Clusters size (1)

Cluster size map 40 V HV



- 2x2 pixel matrix
- Example for HV=40V
- Higher clusters size for tracks passing at the Y edge between two pixels
- Cluster size almost constant for tracks passing at the X edge between two pixels

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Clusters size (2)



• in-pixel X projection for each HV

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 Almost uniform clusters size even at pixel edges



- in-pixel Y projection for each HV
- Mean clusters size increases at pixel edges
- **Discontinuity between 15V and 20V** when the region between pixels gets depleted (as observed before)



Resolution

- **Resolution for 1-pixel and 2-pixels** (row projection) **clusters** in **precise Y direction** (50 µm pitch)
- Distribution of residuals in Y fitted with function $f(x) = [S(x|l,r,C)+G_{bkg}(x|\mu_{bkg},\sigma_{bkg})]*G_{tel}(x|\mu_{tel},\sigma_{tel})$ where





Resolution

- Resolution for 1-pixel and 2-pixels (row projection) clusters in precise Y direction (50 µm pitch)
- Distribution of residuals in Y fitted with function $f(x) = [S(x|l,r,C)+G_{bkg}(x|\mu_{bkg},\sigma_{bkg})]*G_{tel}(x|\mu_{tel},\sigma_{tel})$ where

$$\circ S(x|l,r,C) = \begin{cases} C & l < x < r \\ 0 & elsewhere \end{cases}$$
 is a step-function describing the charge collection region

- $G_{bkg}(x|\mu_{bkg},\sigma_{bkg})$ is a Gaussian background which accounts for tails in the resolution function, for example, due to δ-rays or bremsstrahlung
- $G_{tel}(x|\mu_{tel},\sigma_{tel})$ is a Gaussian function which describes the **telescope resolution**
- width of the step-function (l+r) and σ_{tel} extrapolated from fit to study their variation with HV



1-pixel clusters Y resolution



- Fit function describes the shape of the Y residuals for 1-pixel clusters
- Width of the step function increases from ~44 μm at 2V to ~47 μm at 50 V
- Telescope resolution σ_{tel} improves with increasing HV from ~11.2 µm to ~10.6 µm



2-pixel clusters Y resolution



- Fit function describes the shape of the Y residuals for 2-pixel clusters (size projection along row)
- Width of the step function is constant with HV at ~6 μ m
- Telescope resolution σ_{tel} is very similar to the previous case and improves with increasing HV



Efficiency



- Efficiency increase with HV from ~82.5% at 2V to ~99.8% at 50 V
- Efficiency ~constant for HV>20V when the whole detector area is depleted

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In-pixel efficiency (1)

Pixel Efficiency map 2 V HV

Pixel Efficiency map 5 V HV



- Grouped **2x2** pixel **matrix**
- Higher efficiency in pixel centre, lower efficiency at the edges and at the corners, where the charge is shared between four pixels



In-pixel efficiency (2)

Pixel Efficiency map 10 V HV

Pixel Efficiency map 15 V HV



- Grouped **2x2** pixel **matrix**
- Efficiency become more uniform across the pixel (note the different Z-scale)



In-pixel efficiency (3)

Pixel Efficiency map 20 V HV

Pixel Efficiency map 30 V HV



- Grouped **2x2** pixel **matrix**
- Efficiency become more uniform across the pixel (note the different Z-scale)



In-pixel efficiency (4)

Pixel Efficiency map 40 V HV

Pixel Efficiency map 50 V HV



- Grouped **2x2** pixel **matrix**
- Efficiency becomes uniform across the pixel for HV≥40 V





- In-pixel efficiency **projection along X** (long side) **and Y** (short side)
- Bigger efficiency at pixel centre in both directions

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• Efficiency becomes uniform in both direction when the whole detector area is depleted



- ATLASPix3 is one of the candidates for the CEPC Silicon Tracker and with the presented analysis we have observed that:
 - cross-talk hits can be reduced to ~1% of the total hits
 - the **performance** is **uniform** for **HV>20V**:
 - efficiency >99%
 - avoid charge losses
 - the telescope resolution gets better for increasing HV
- Many other data have been collected at the DESY Testbeam
 - different energies
 - different angles
- More precise extrapolation is needed to achieve a more precise mapping of efficiency and charge collection



THANKS FOR THE ATTENTION

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BACKUP

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Pixel cross-section



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Cluster size (1)



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1.16_@

1.14

1.12

1.1

1.08

1.06

1.04

1.22

1.2

1.18

1.16

1.14

1.12

1.1

1.08

1.06

1.04

1.02

100 150 in-pixel x [µm]

50

50

100 150 in-pixel x [µm]



Cluster size (2)





Cluster charge (1)





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Cluster charge (2)



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1-pixel cluster charge (1)

1px cluster charge map 10 V HV



1px cluster charge map 50 V HV 118 118 LOL 14 1 101 40 112 116 oixel 30 ċ 114 110 112 108 110 108 -20 106 -30 106 04 -40 -50 50 50 100 150 in-pixel x [µm] -100 -50 50 100 150 in-pixel x [µm] 0

-100

-50

1px cluster charge map 15 V HV

50

100 150 in-pixel x [µm]

102 SE LoL

-98

-96

- 94

92



1px cluster charge map 30 V HV

-50

1px cluster charge map 5 V HV

ToT [TS]

94

-92

-90

-88

86

84

100 150 in-pixel x [µm] [mm]

-40 -50

-100

-50





1px cluster charge map 20 V HV

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98 [m] [m]

96

92

90

88

100 150 in-pixel x [µm] -20

-50 50



1-pixel cluster charge (2)



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2-pixel cluster charge (1)







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2px cluster charge map 15 V HV

50

100 150 in-pixel x [µm]

-100

-50

230 [SL]

210

200

190

180

170



2-pixel cluster charge (2)



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100 150 in-pixel χ [μm]

-100

Second pixel charge map 2 V HV









Second pixel charge map 20 V HV

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100 [SL]

90

80

95 ToT

90

- 85

80

75

70





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2-pixel cluster charge - second pixel (1)





90

88

-86 0/

80







-50

-50 50

Second pixel charge map 15 V HV

50

100 150 in-pixel x 150 100 E

95 90

85

80 75

Second pixel charge map 40 V HV



Second pixel charge map 30 V HV



-59 50

-100

-50

Second pixel charge map 20 V HV







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Residuals



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